



# Schottky Barrier Diode

## Features

1. High reliability
2. Low reverse current and low forward voltage



## Applications

Low current rectification and high speed switching

## Absolute Maximum Ratings

T<sub>a</sub>=25°C

Parameter	Symbol	Limits	Unit
Peak reverse voltage	V <sub>RM</sub>	40	V
DC reverse voltage	V <sub>R</sub>	40	V
Mean rectifying current	I <sub>O</sub>	0.1	A
Peak forward surge current	I <sub>FSM</sub>	1	A
Junction temperature	T <sub>j</sub>	125	°C
Storage temperature	T <sub>stg</sub>	-40~+125	°C

Stresses exceeding maximum ratings may damage the device. Maximum ratings are stress ratings only. Functional operation above the recommended operating conditions is not implied. Extended exposure to stresses above the recommended operating conditions may affect device reliability.

## Electrical Characteristics

T<sub>a</sub>=25°C

Parameter	Symbol	Conditions	Min	Type	Max	Unit
Forward voltage	V <sub>F1</sub>	I <sub>F</sub> =10mA	-	0.28	0.34	V
Forward voltage	V <sub>F2</sub>	I <sub>F</sub> =100mA	-	0.45	0.55	V
Reverse current	I <sub>R</sub>	V <sub>R</sub> =40V	-	9.0	100	µA
Capacitance between terminals	C <sub>T</sub>	V <sub>R</sub> =10V, f=1MHz	-	6.0	-	pF

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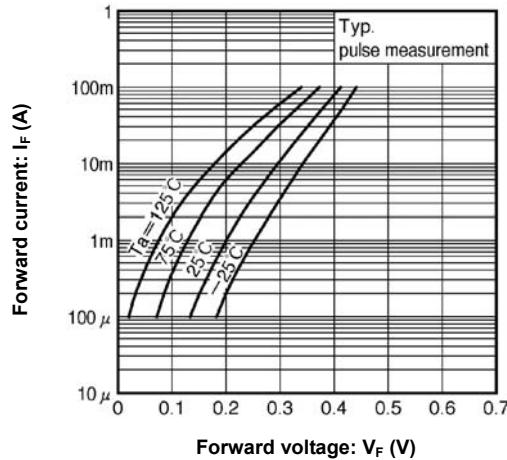
**Characteristics (Ta=25°C unless specified otherwise)**

Figure 1. Forward characteristics

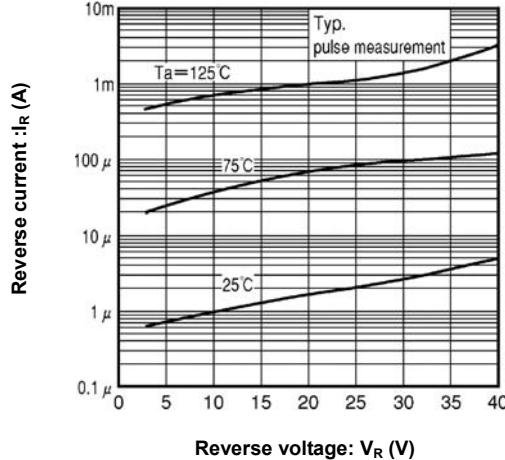


Figure 2. Reverse characteristics

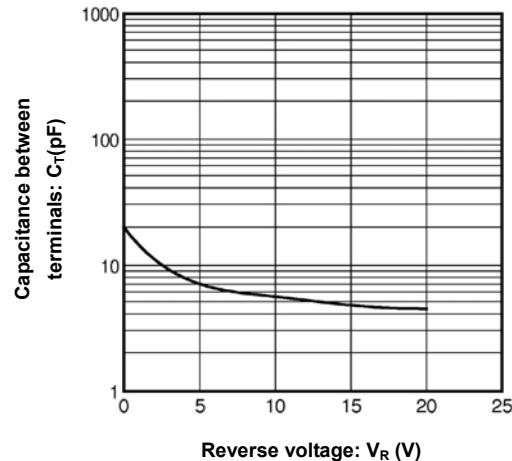


Figure 3. Capacitance between terminals characteristics

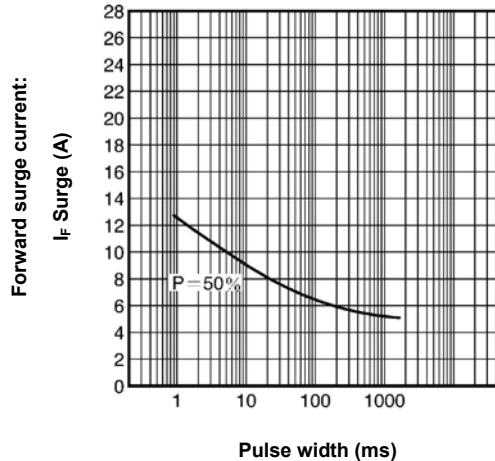


Figure 4. Forward surge current characteristics

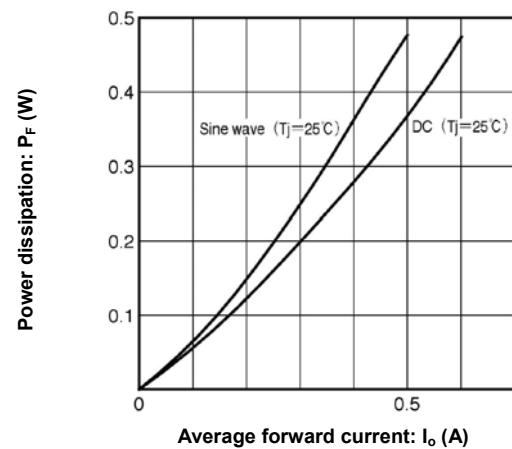


Figure 5. Mean rectifying current characteristics

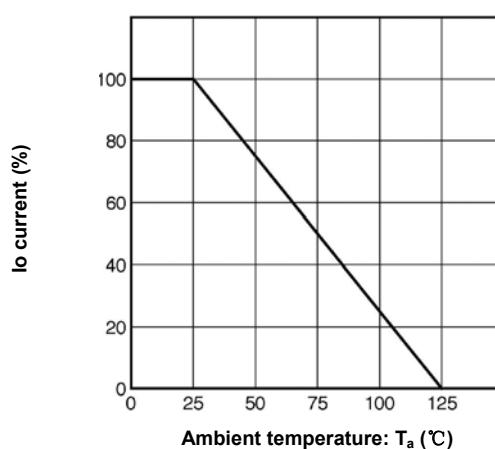
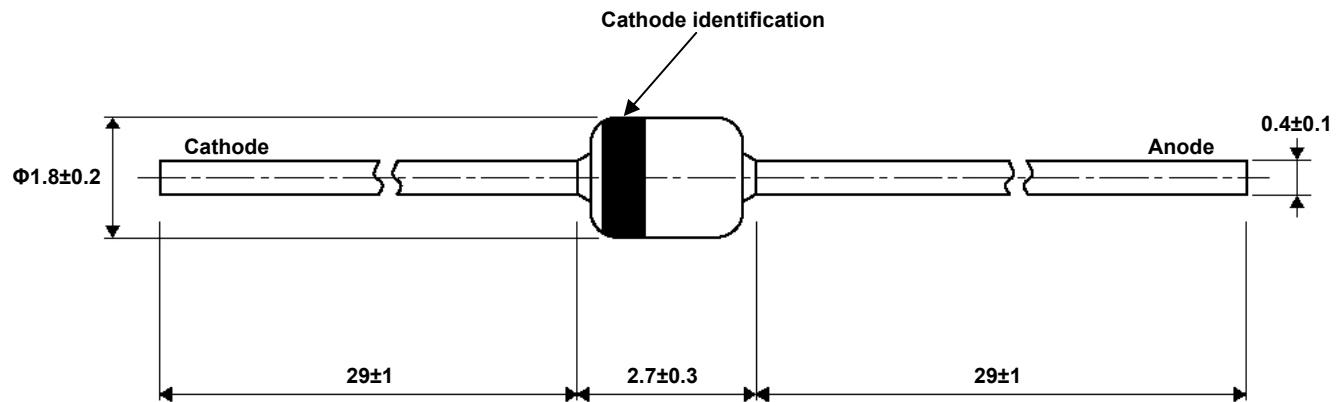


Figure 6. Derating curve (mounting on glass epoxy PCBs)

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## Dimensions in mm



Standard Glass Case  
JEDEC DO-34

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